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# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Derek Lindsay	12/05/2007

### **RECEIVING PARTY DATA**

Name:	Honda Motor Co., Ltd		
Street Address:	No. 1-1, Minami-Aoyama 2-chome		
Internal Address:	Minato-ku		
City:	Tokyo		
State/Country:	JAPAN		
Postal Code:	107-8556		

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11872204

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	30515.45845	
NAME OF SUBMITTER:	Dominic A. Frisina	

Total Attachments: 1

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PATENT REEL: 022172 FRAME: 0920

Docket No.:

30515.45845

Application No.:

11/872,204

Filed Date:

October 15, 2007

### ASSIGNMENT

WHEREAS, I, Derek Lindsay of Marysville, OH have invented certain improvements in SELF-ALIGNING ELECTRICAL CONTACT AND RELATED METHODS, and described in a patent application executed the day of December 2007, by the undersigned for filing in The United States of America, being owner of all right, title, and interest in and to said application and in and to any invention described therein and having full right to convey the entire interest both legal and equitable herein assigned; and

WHEREAS, Honda Motor Co., LTD, No.1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo 107-8556, a corporation of JAPAN (assignee) is desirous of acquiring the entire right, title, and interest in and to said application and said invention described therein and any and all patents to be obtained therefore, all as hereinafter set forth:

NOW, THEREFORE, in consideration of good and valuable consideration received by the undersigned, the undersigned does hereby sell, assign, transfer, and set over unto said assignee, its successors and assigns, the entire right, title, and interest in and to said invention or inventions, as described in the aforesaid application, in any form or embodiment thereof, and in and to the aforesaid application; and in and to any application filed in any foreign country based thereon, including the right to file said foreign applications under the provisions of the International Convention; also the entire right, title, and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon said invention or inventions and any divisional, continuation, continuation-in-part, or substitute applications which may be filed upon said invention or inventions in this or any foreign country; and the undersigned hereby authorizes and requests the issuing authority to issue any and all patents on said application or applications to said assignee or its successors and assigns.

The undersigned further agrees to execute all divisional, continuing, substitute, improvement, extension, reissue, and other patent applications in this or any foreign country relating to said application or invention and to sign all other lawful papers and to perform all other lawful acts without further consideration, but without expense to myself, which the assignee may deem necessary or desirable to make this Assignment fully effective including by way of example, but not of limitation, the following acts:

- (1) Prompt execution of all lawful oaths, affidavits, and/or supplemental oaths required or deemed advisable by the assignee to further the prosecution of any application or applications for letters patent relating to the subject matter of this Assignment;
- (2) To co-operate to the best of my ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, nullification, or infringement proceedings involving the said invention or improvement, applications or patents or any of them.

The undersigned hereby authorizes said assignee to insert in this Assignment the serial number and filing date of the above-identified application when known.

IN WI	TNESS WHERE	OF, the undersig	med has hereui	nto set his hand	l and seal on th	ne date set after his
signature.			Dorek _	<u>Lilie</u>	<u>,                                    </u>	<u> 2/5</u> , 2007
			Derek Linds	say 🐷	)	<sup>2</sup> Date
State of OHIO		)		•		
City of Roy	mond	) SS:				
7-7	4/14-		1			
On this	: day of	( ( h acasa	him :	2007. hefore	me nersonally	appeared Derek
Lindsay person	ally known, and	known to me	to be the perso	ones) who sign	ed the foregoir	ng assignment, and
acknowledge th	e signing of same	as his free act an	d deed.	// // // // // // // // // // // // //	ou market gom	.6 455161410111, 4114
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PATENT REEL: 022172 FRAME: 0921

**RECORDED: 01/29/2009**